

PATENT APPLICATION

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October 11, 2006

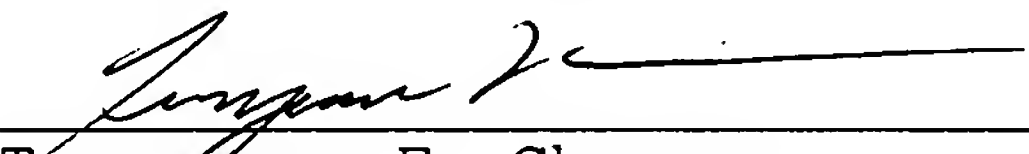
Applicants : Toshihiro TAI et al  
For : PLATED RESIN MOLDED ARTICLES  
PCT International Application No.: PCT/JP2005/002827  
PCT International Filing Date: February 16, 2005  
U.S. Application No.  
(if known, see 37 CFR 1.5): 10/586 378  
Atty. Docket No.: 3400.P1434US  
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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**INFORMATION DISCLOSURE STATEMENT**

Sir:

In compliance with the provisions of Rules 1.97(b)(1) and 1.98, enclosed herewith is a copy of the International Search Report, Form PTO-1449 and the references cited thereon. The relevance of these references is explained on the enclosed search report. The remaining references are mentioned in Applicants' specification. Further comment at this point in time should not be necessary.

Respectfully submitted,

  
Terryence F. Chapman

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Encl: International Search Report  
Form PTO-1449 and one copy of each reference listed  
thereon

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INFORMATION DISCLOSURE CITATION	Applicant: Toshihiro TAI et al		
	Ser.No.: 10/586 378		Filed: July 14, 2006
	Conf. No.: 2951		Atty. Docket No.: 3400.P1434US
	Group: 1714		Date: October 11, 2006

## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No.	Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant
	AA			
	AB			
	AC			
	AD			
	AE			
	AF			
	AG			
	AH			
	AI			
	AJ			
	AK			

## FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No.	Country Code - Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Trans.
	AL	JP 7-330934	12-19-1995	HOYA et al	Abstract
	AM	JP 57-123048	07-31-1982		
	AN	JP 59-142244	08-15-1984	OKITA et al	Abstract
	AO	JP 2004-2996	01-08-2004	TAI et al	Abstract
	AP	JP 2003-82138	03-19-2003	TAI et al	Abstract
	AQ	JP 2003-166067	06-13-2003	SOTOZAKI et al	Abstract

## NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No.	(Include Author, Title, Date, Pages, Etc.)
	AQ	
	AR	
EXAMINER SIGNATURE		DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.